



US00D550656S

(12) **United States Design Patent**
Gerdom et al.

(10) **Patent No.:** **US D550,656 S**

(45) **Date of Patent:** **** Sep. 11, 2007**

(54) **PAIR OF BONE CONDUCTION HEADSET HOUSINGS CONFIGURABLE FOR LEFT OR RIGHT SIDE MICROPHONE PLACEMENT**

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(**) Term: **14 Years**

(21) Appl. No.: **29/248,215**

(22) Filed: **Aug. 3, 2006**

(51) **LOC (8) Cl.** **14-01**

(52) **U.S. Cl.** **D14/223**

(58) **Field of Classification Search** D14/142, D14/192, 205–206, 223; 181/129–130, 132; 381/331, 377, 380–381, 151, 327; 379/430, 379/433–434; 455/344, 351

See application file for complete search history.

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(57) **CLAIM**

The ornamental design for a pair of bone conduction headset housings configurable for left or right side microphone placement, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of a pair of bone conduction headset housings configurable for left or right side microphone placement showing our new design, the broken lines showing the microphone cord and vertically oriented headband being for illustrative purposes only and forming no part of the claimed design.

FIG. 2 is an enlarged, left side elevational view of the left side housing thereof, shown separately for clarity of illustration.

FIG. 3 is a top plan view of the left side housing of FIG. 2.

FIG. 4 is a right side elevational view thereof.

FIG. 5 is a rear elevational view thereof.

FIG. 6 is a bottom plan view thereof.

FIG. 7 is an enlarged, right side elevational view of the right side housing illustrated in FIG. 1, shown separately for clarity of illustration.

FIG. 8 is a front elevational view thereof.

FIG. 9 is a bottom plan view thereof.

FIG. 10 is a left side elevational view thereof.

FIG. 11 is a rear elevational view thereof.

FIG. 12 is a perspective view of an alternative embodiment of a pair of bone conduction headset housings configurable for left or right side microphone placement showing our new design, the broken lines showing the microphone cord and horizontally oriented headband being for illustrative purposes only and forming no part of the claimed design; and,

FIG. 13 is a perspective view of the housings of FIG. 12 configured to provide right side microphone placement.

1 Claim, 4 Drawing Sheets

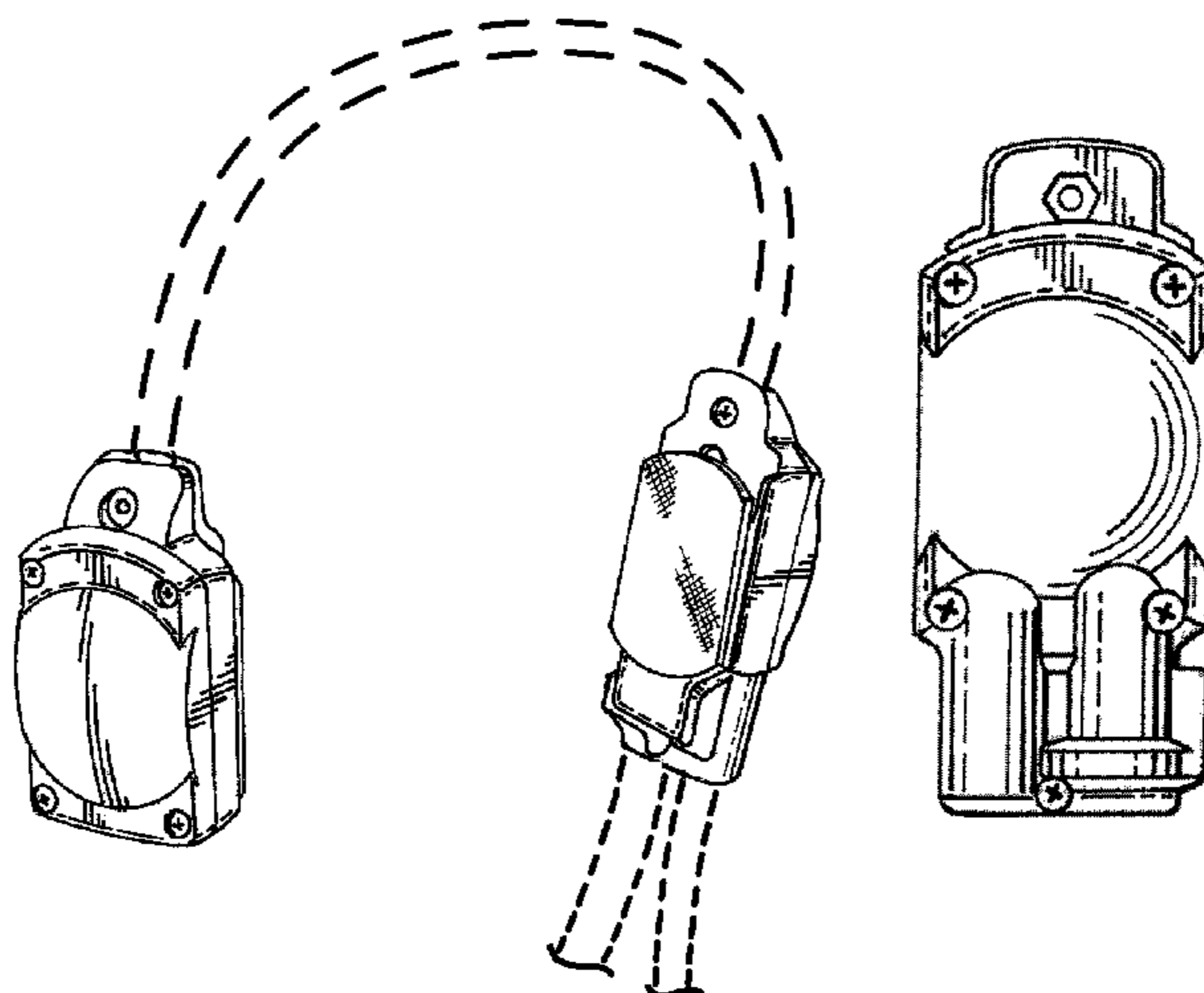


Fig. 1

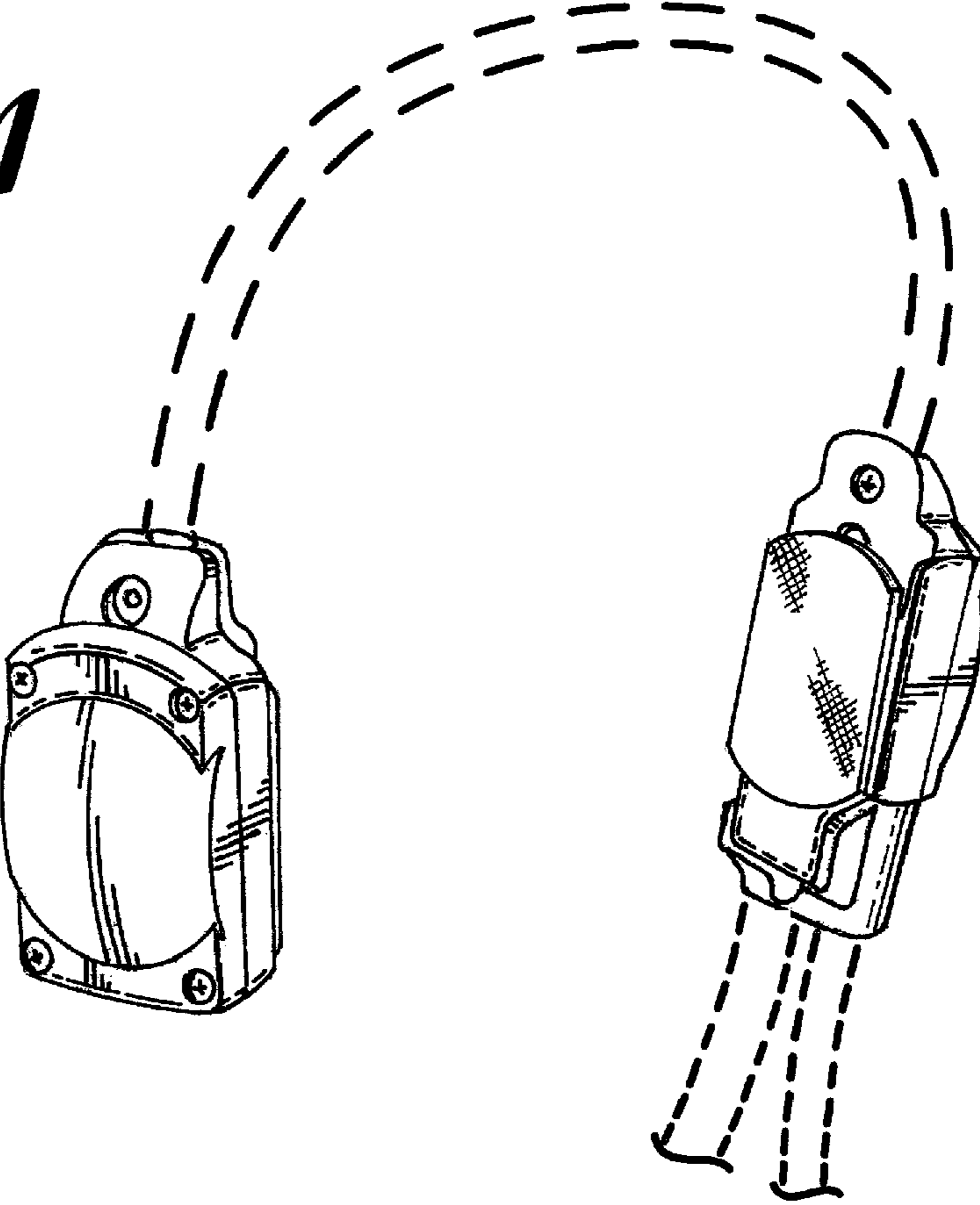


Fig. 2

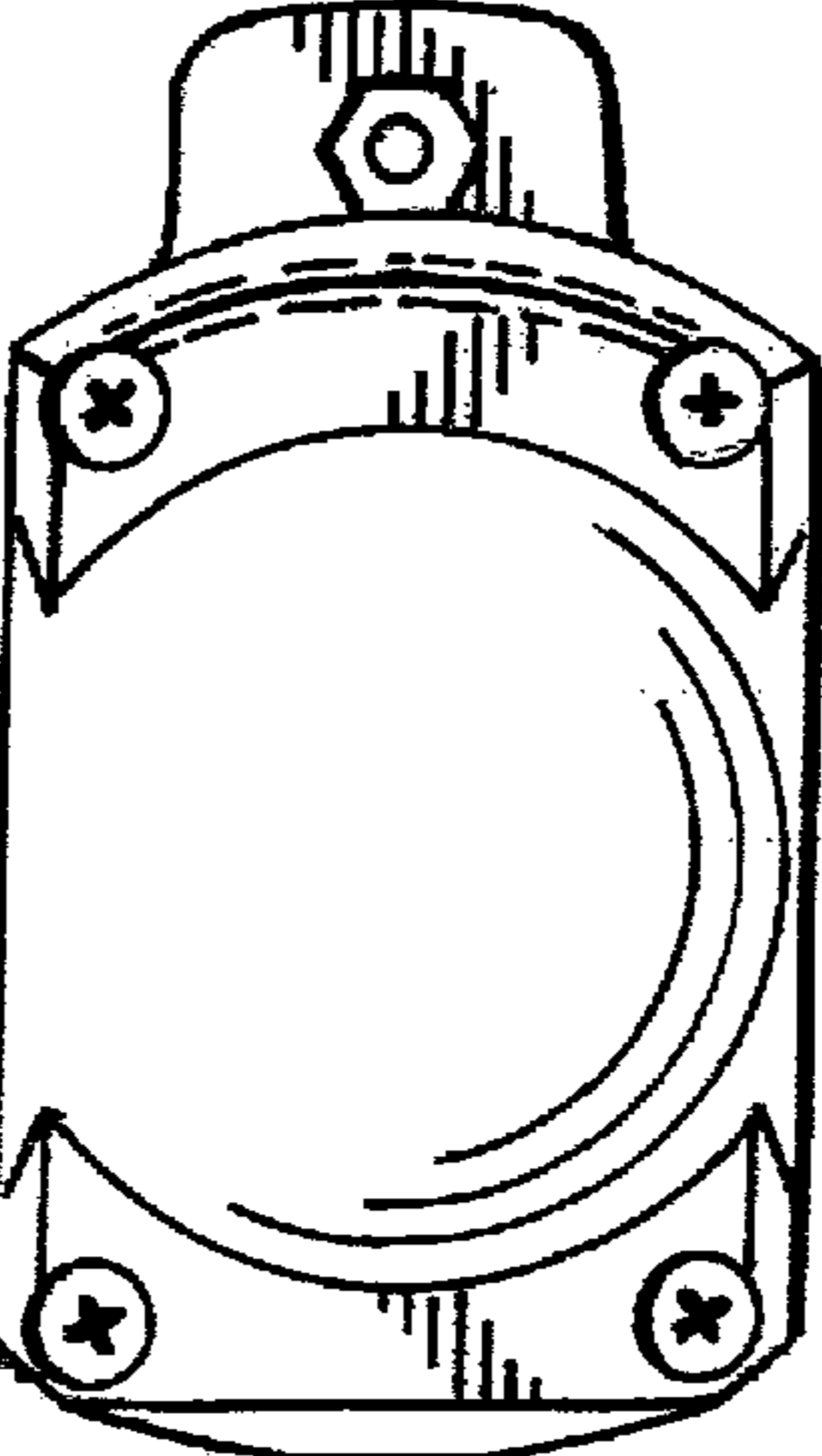


Fig.3.

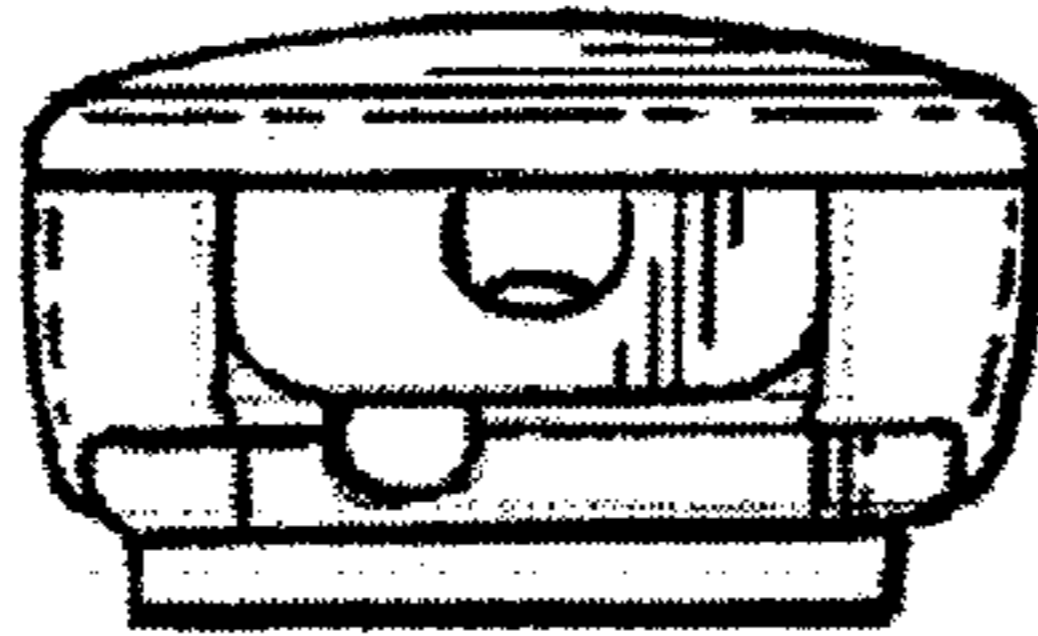


Fig.4.

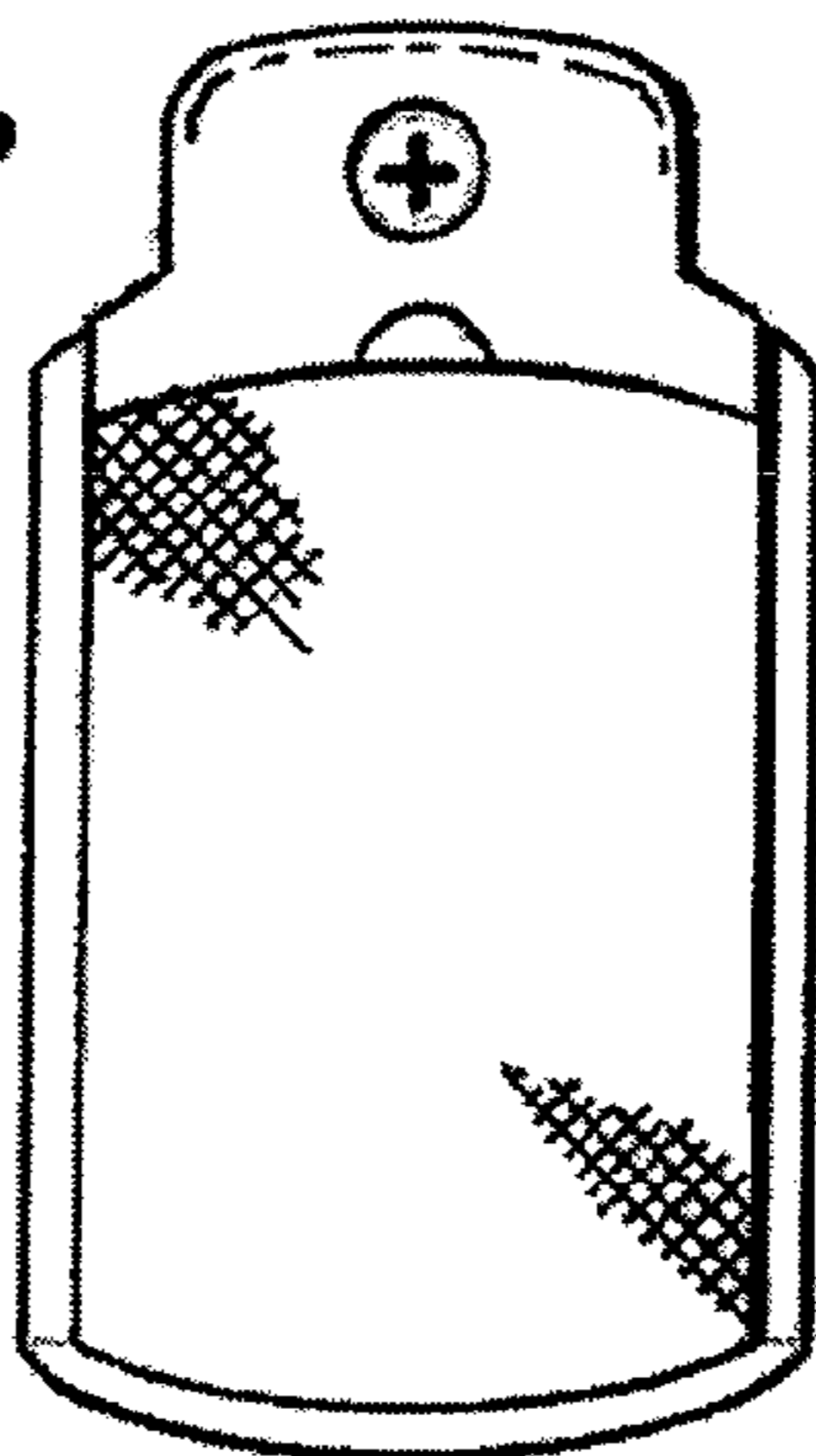


Fig.5.



Fig.6.

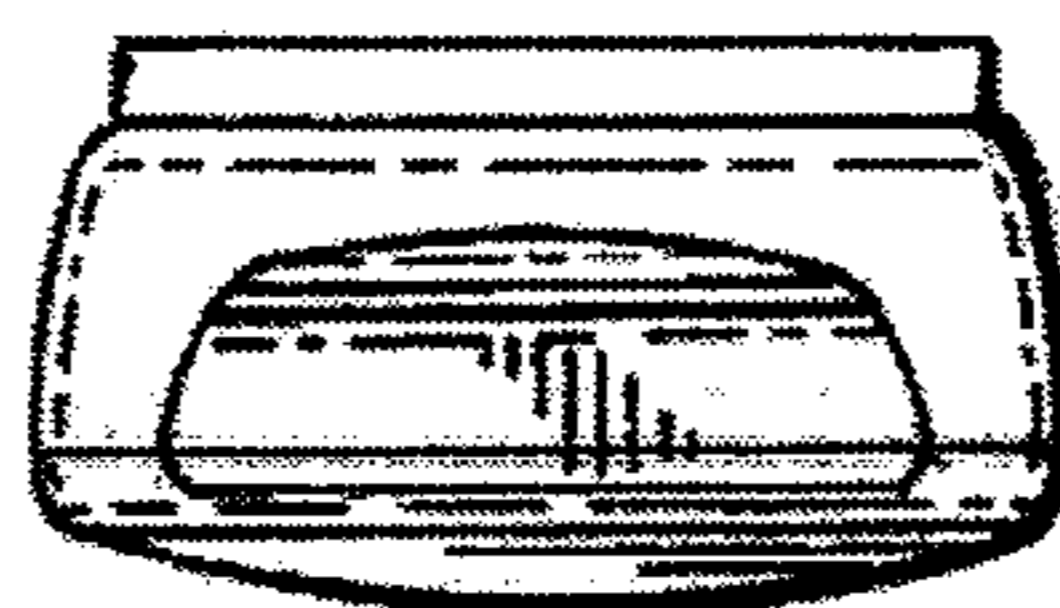


Fig. 7

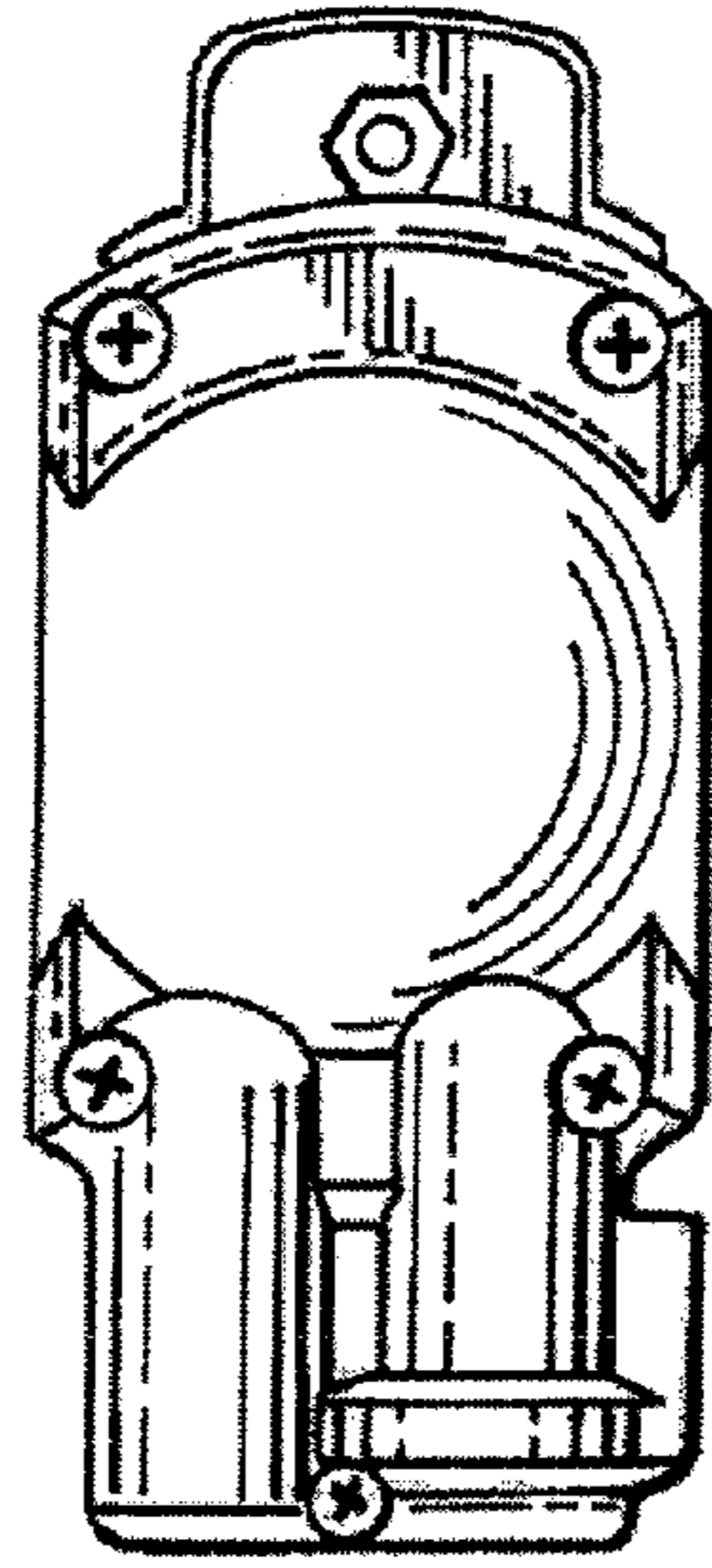


Fig. 8

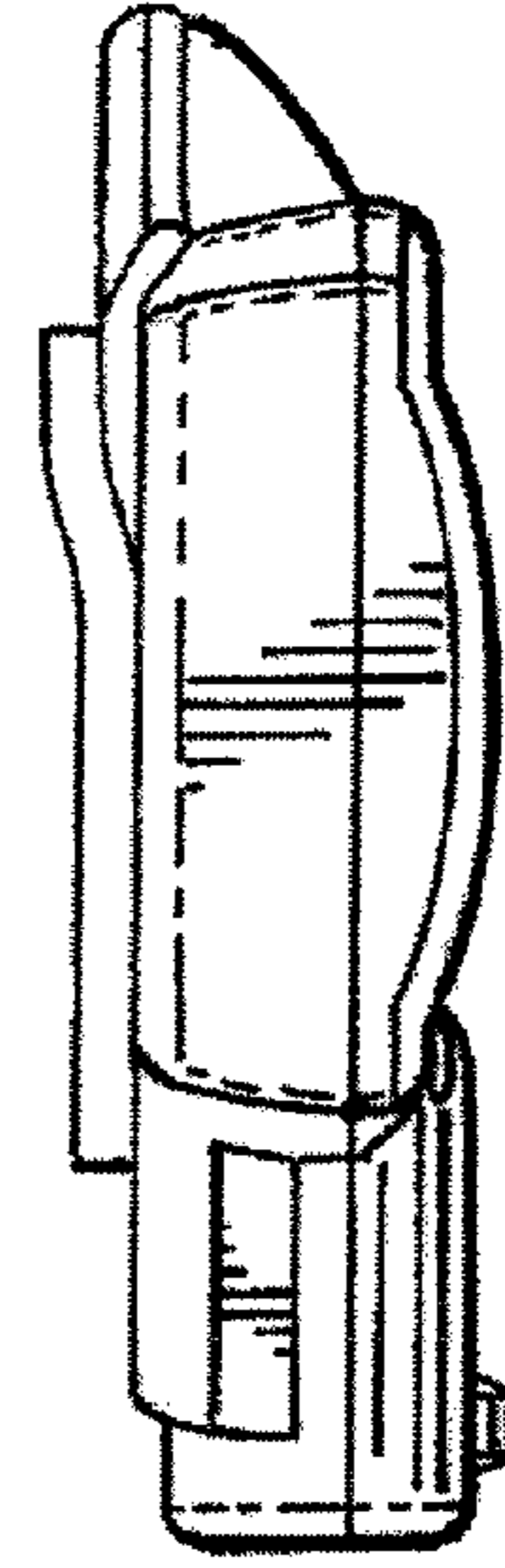


Fig. 9

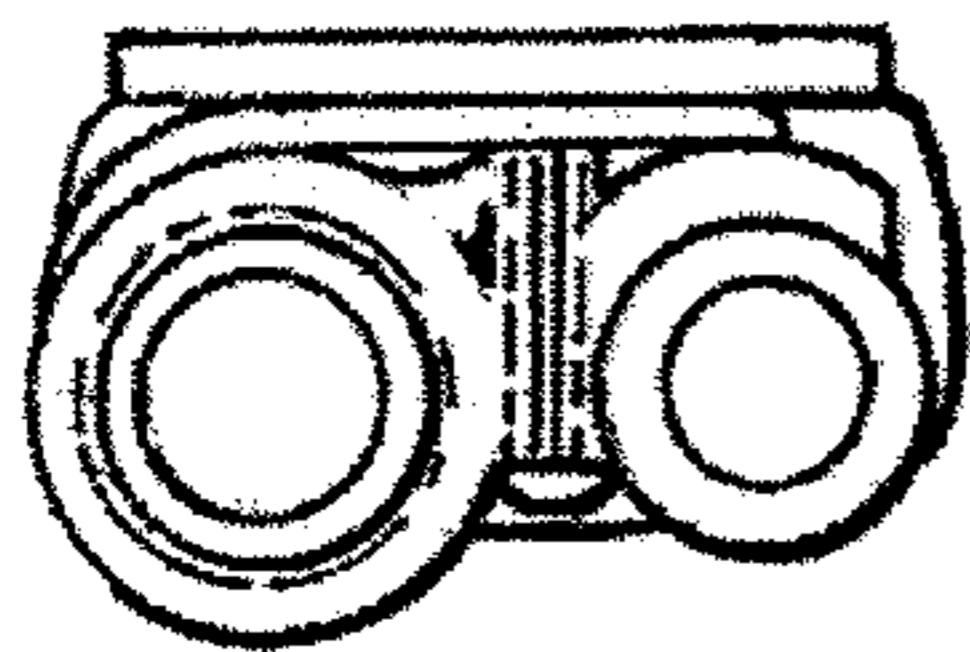


Fig. 10

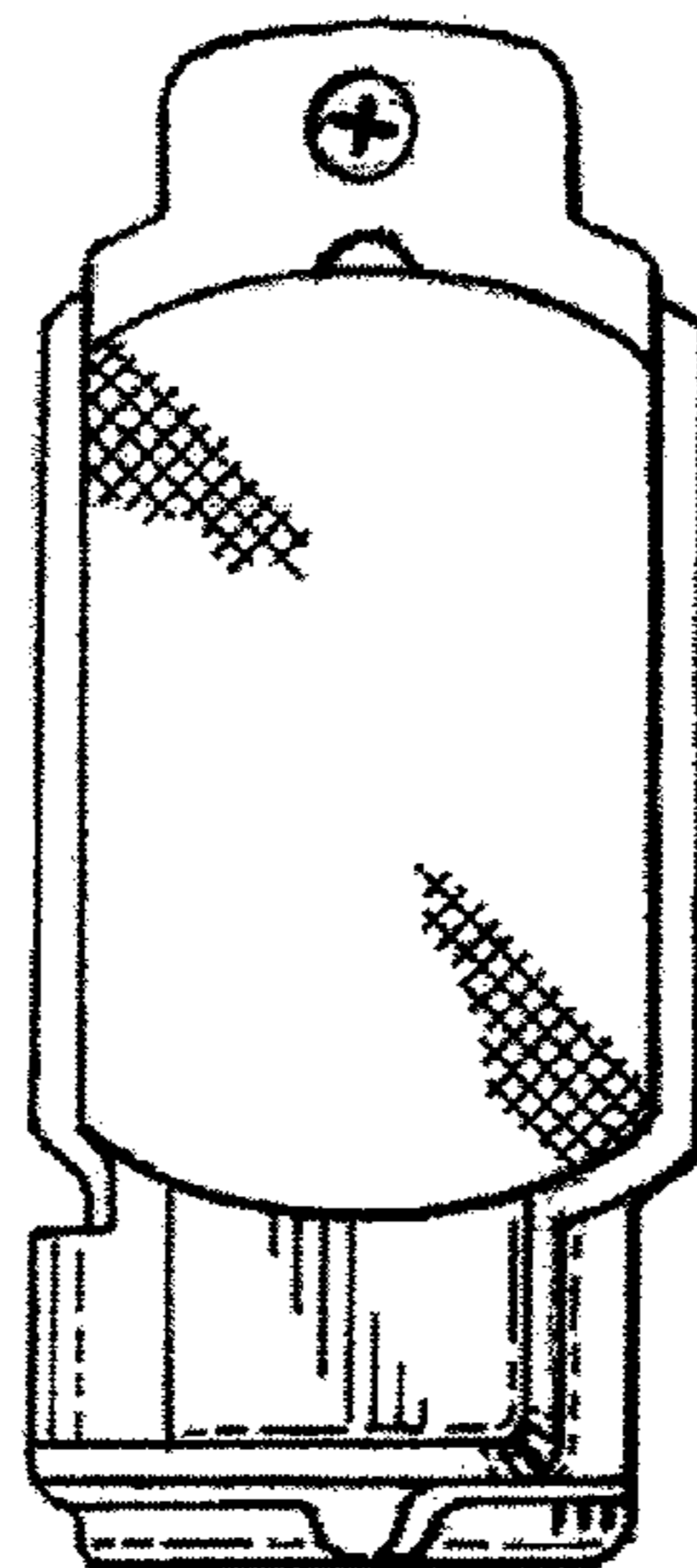


Fig. 11

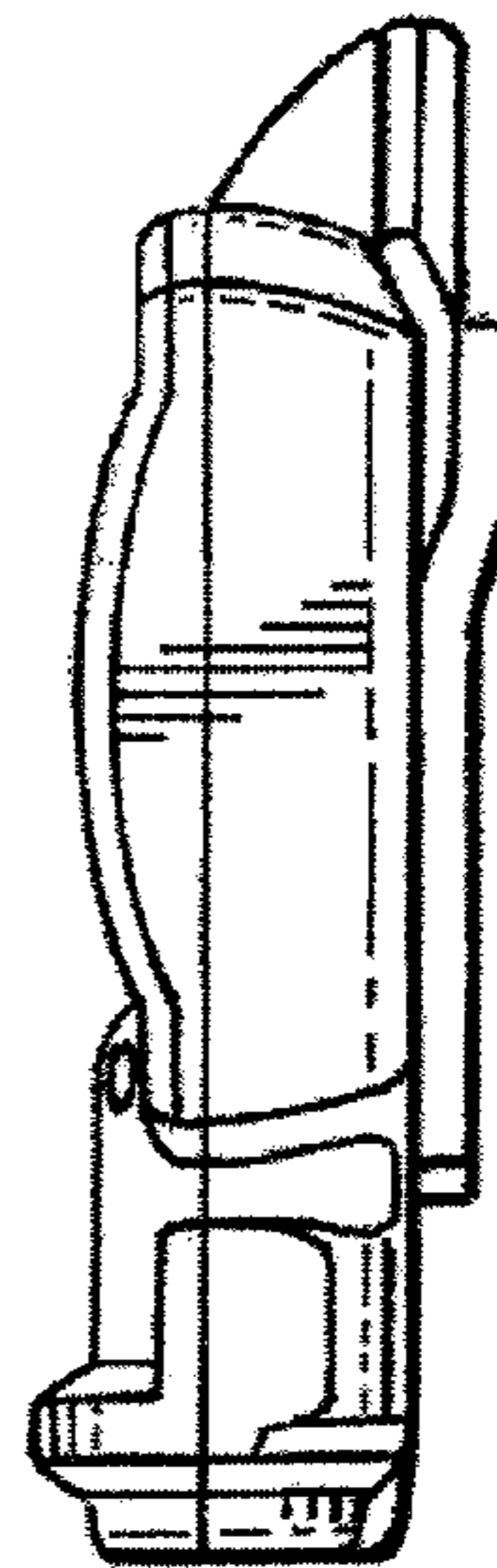


Fig. 12

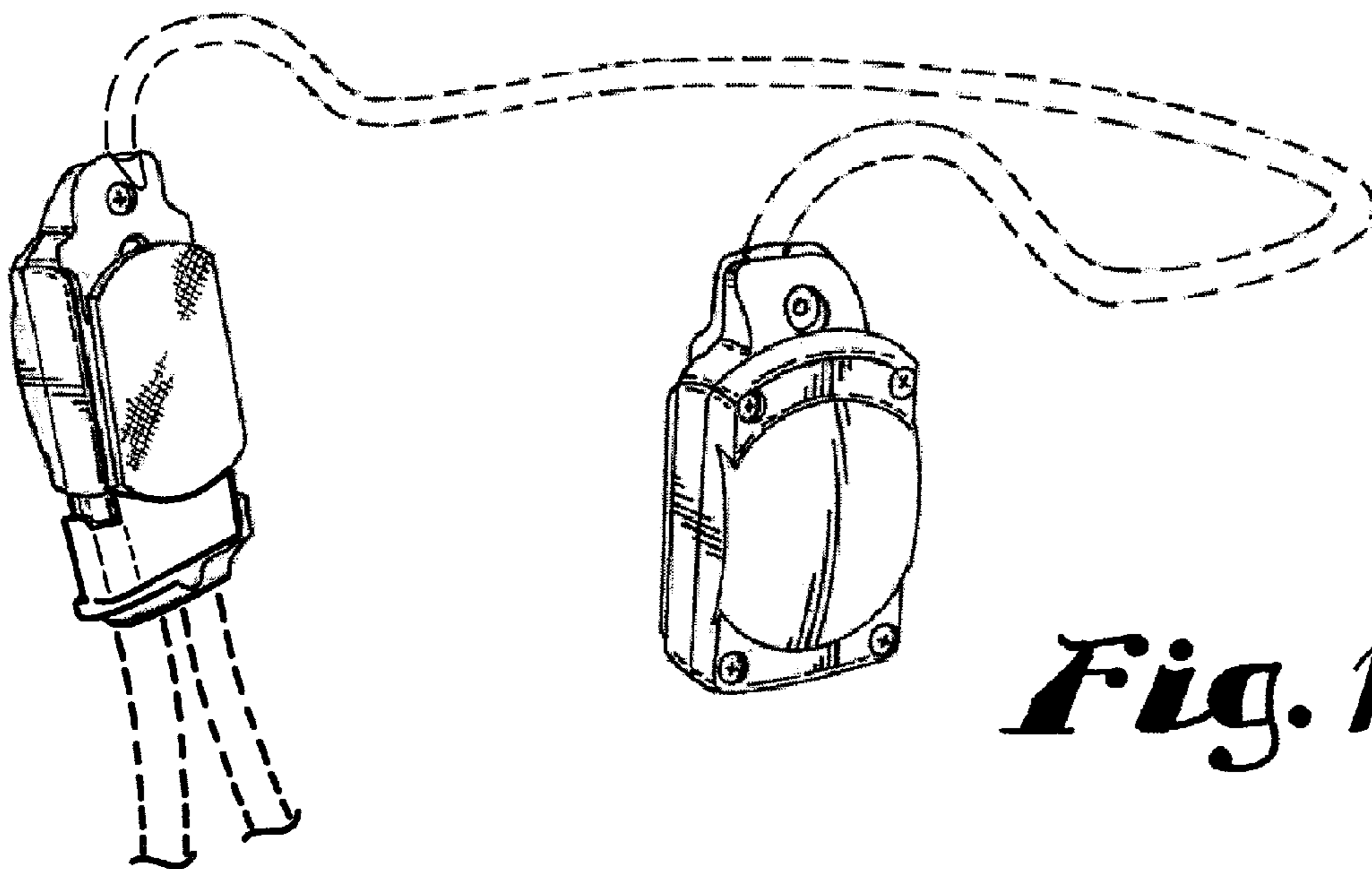
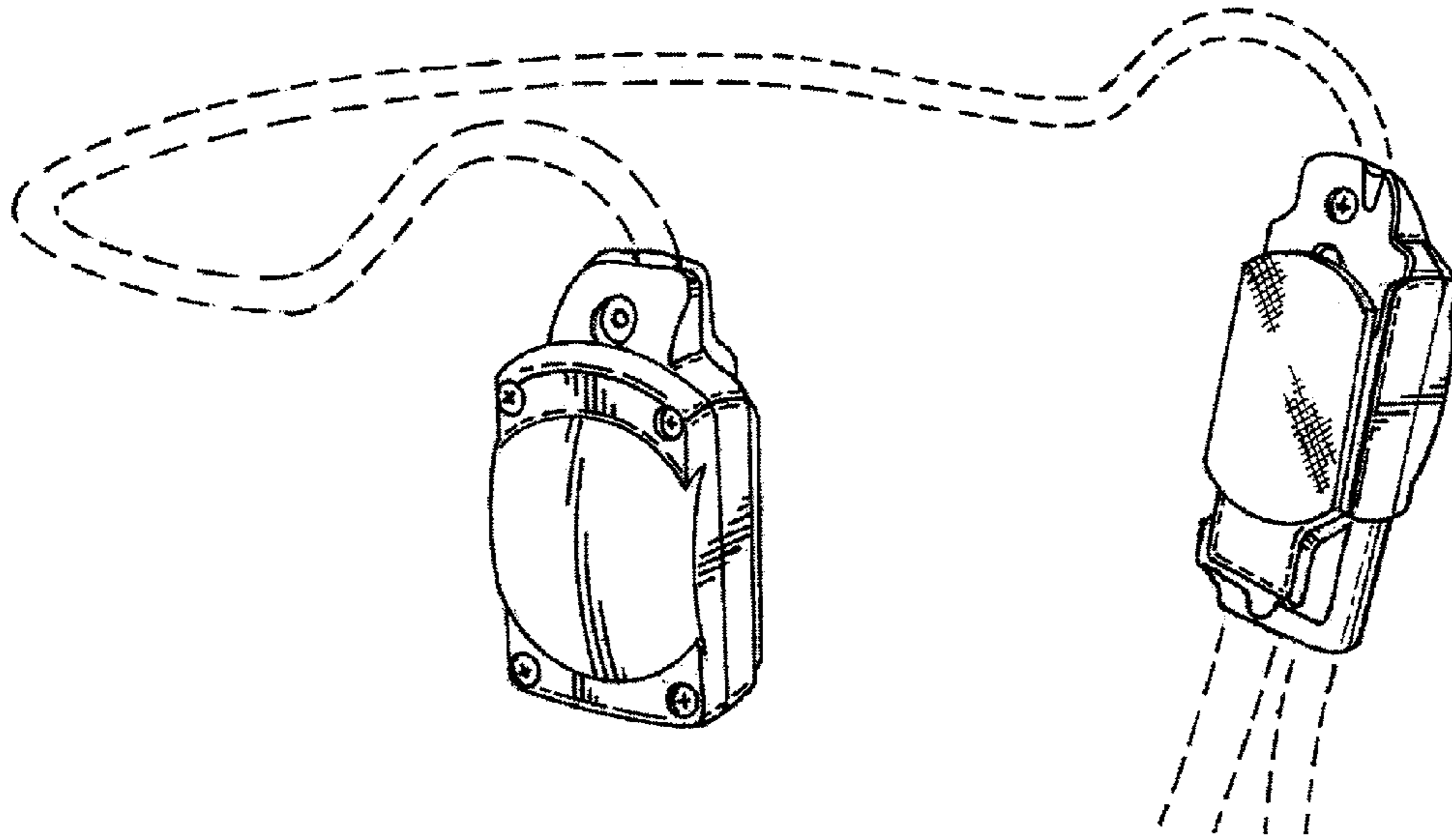


Fig. 13